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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Active
Number of LABs/CLBs	192
Number of Logic Elements/Cells	1728
Total RAM Bits	73728
Number of I/O	63
Number of Gates	50000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	100-TQFP
Supplier Device Package	100-VQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s50-4vqg100c

IOBs

For additional information, refer to the chapter entitled “Using I/O Resources” in [UG331: Spartan-3 Generation FPGA User Guide](#).

IOB Overview

The Input/Output Block (IOB) provides a programmable, bidirectional interface between an I/O pin and the FPGA’s internal logic.

A simplified diagram of the IOB’s internal structure appears in [Figure 7](#). There are three main signal paths within the IOB: the output path, input path, and 3-state path. Each path has its own pair of storage elements that can act as either registers or latches. For more information, see the [Storage Element Functions](#) section. The three main signal paths are as follows:

- The input path carries data from the pad, which is bonded to a package pin, through an optional programmable delay element directly to the I line. There are alternate routes through a pair of storage elements to the IQ1 and IQ2 lines. The IOB outputs I, IQ1, and IQ2 all lead to the FPGA’s internal logic. The delay element can be set to ensure a hold time of zero.
- The output path, starting with the O1 and O2 lines, carries data from the FPGA’s internal logic through a multiplexer and then a three-state driver to the IOB pad. In addition to this direct path, the multiplexer provides the option to insert a pair of storage elements.
- The 3-state path determines when the output driver is high impedance. The T1 and T2 lines carry data from the FPGA’s internal logic through a multiplexer to the output driver. In addition to this direct path, the multiplexer provides the option to insert a pair of storage elements. When the T1 or T2 lines are asserted High, the output driver is high-impedance (floating, hi-Z). The output driver is active-Low enabled.
- All signal paths entering the IOB, including those associated with the storage elements, have an inverter option. Any inverter placed on these paths is automatically absorbed into the IOB.

Storage Element Functions

There are three pairs of storage elements in each IOB, one pair for each of the three paths. It is possible to configure each of these storage elements as an edge-triggered D-type flip-flop (FD) or a level-sensitive latch (LD).

The storage-element-pair on either the Output path or the Three-State path can be used together with a special multiplexer to produce Double-Data-Rate (DDR) transmission. This is accomplished by taking data synchronized to the clock signal’s rising edge and converting them to bits synchronized on both the rising and the falling edge. The combination of two registers and a multiplexer is referred to as a Double-Data-Rate D-type flip-flop (FDDR). See [Double-Data-Rate Transmission, page 12](#) for more information.

The signal paths associated with the storage element are described in [Table 5](#).

Table 5: Storage Element Signal Description

Storage Element Signal	Description	Function
D	Data input	Data at this input is stored on the active edge of CK enabled by CE. For latch operation when the input is enabled, data passes directly to the output Q.
Q	Data output	The data on this output reflects the state of the storage element. For operation as a latch in transparent mode, Q will mirror the data at D.
CK	Clock input	A signal’s active edge on this input with CE asserted, loads data into the storage element.
CE	Clock Enable input	When asserted, this input enables CK. If not connected, CE defaults to the asserted state.
SR	Set/Reset	Forces storage element into the state specified by the SRHIGH/SRLOW attributes. The SYNC/ASYN attribute setting determines if the SR input is synchronized to the clock or not.
REV	Reverse	Used together with SR. Forces storage element into the state opposite from what SR does.

Table 20: PS Attributes

Attribute	Description	Values
CLKOUT_PHASE_SHIFT	Disables PS component or chooses between Fixed Phase and Variable Phase modes.	NONE, FIXED, VARIABLE
PHASE_SHIFT	Determines size and direction of initial fine phase shift.	Integers from -255 to +255 ⁽¹⁾

Notes:

- The practical range of values will be less when $T_{CLKIN} > FINE_SHIFT_RANGE$ in the Fixed Phase mode, also when $T_{CLKIN} > (FINE_SHIFT_RANGE)/2$ in the Variable Phase mode. the $FINE_SHIFT_RANGE$ represents the sum total delay of all taps.

The Variable Phase Mode

The “Variable Phase” mode dynamically adjusts the fine phase shift over time using three inputs to the PS component, namely PSEN, PSCLK and PSINCDEC, as defined in [Table 21](#).

After device configuration, the PS component initially determines T_{PS} by evaluating Equation (4) for the value assigned to the PHASE_SHIFT attribute. Then to dynamically adjust that phase shift, use the three PS inputs to increase or decrease the fine phase shift.

PSINCDEC is synchronized to the PSCLK clock signal, which is enabled by asserting PSEN. It is possible to drive the PSCLK input with the CLKIN signal or any other clock signal. A request for phase adjustment is entered as follows: For each PSCLK cycle that PSINCDEC is High, the PS component adds 1/256 of a CLKIN cycle to T_{PS} . Similarly, for each enabled PSCLK cycle that PSINCDEC is Low, the PS component subtracts 1/256 of a CLKIN cycle from T_{PS} . The phase adjustment may require as many as 100 CLKIN cycles plus three PSCLK cycles to take effect, at which point the output PSDONE goes High for one PSCLK cycle. This pulse indicates that the PS component has finished the present adjustment and is now ready for the next request. Asserting the Reset (RST) input, returns T_{PS} to its original shift time, as determined by the PHASE_SHIFT attribute value. The set of waveforms in section [c] of [Figure 23, page 41](#) illustrates the relationship between CLKFB and CLKIN in the Variable Phase mode.

Table 21: Signals for Variable Phase Mode

Signal	Direction	Description
PSEN ⁽¹⁾	Input	Enables PSCLK for variable phase adjustment.
PSCLK ⁽¹⁾	Input	Clock to synchronize phase shift adjustment.
PSINCDEC ⁽¹⁾	Input	Chooses between increment and decrement for phase adjustment. It is synchronized to the PSCLK signal.
PSDONE	Output	Goes High to indicate that present phase adjustment is complete and PS component is ready for next phase adjustment request. It is synchronized to the PSCLK signal.

Notes:

- It is possible to program this input for either a true or inverted polarity

Table 47: Output Timing Adjustments for IOB (Cont'd)

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
HSLVDCI_25			0.27	0.31	ns
HSLVDCI_33			0.28	0.32	ns
HSTL_I			0.60	0.69	ns
HSTL_I_DCI			0.59	0.68	ns
HSTL_III			0.19	0.22	ns
HSTL_III_DCI			0.20	0.23	ns
HSTL_I_18			0.18	0.21	ns
HSTL_I_DCI_18			0.17	0.19	ns
HSTL_II_18			-0.02	-0.01	ns
HSTL_II_DCI_18			0.75	0.86	ns
HSTL_III_18			0.28	0.32	ns
HSTL_III_DCI_18			0.28	0.32	ns
LVCMOS12	Slow	2 mA	7.60	8.73	ns
		4 mA	7.42	8.53	ns
		6 mA	6.67	7.67	ns
	Fast	2 mA	3.16	3.63	ns
		4 mA	2.70	3.10	ns
		6 mA	2.41	2.77	ns
LVCMOS15	Slow	2 mA	4.55	5.23	ns
		4 mA	3.76	4.32	ns
		6 mA	3.57	4.11	ns
		8 mA	3.55	4.09	ns
		12 mA	3.00	3.45	ns
	Fast	2 mA	3.11	3.57	ns
		4 mA	1.71	1.96	ns
		6 mA	1.44	1.66	ns
		8 mA	1.26	1.44	ns
		12 mA	1.11	1.27	ns
LVDCI_15			1.51	1.74	ns
LVDCI_DV2_15			1.32	1.52	ns

Table 47: Output Timing Adjustments for IOB (Cont'd)

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units		
			Speed Grade				
			-5	-4			
LVCMOS18	Slow	2 mA	5.49	6.31	ns		
		4 mA	3.45	3.97	ns		
		6 mA	2.84	3.26	ns		
		8 mA	2.62	3.01	ns		
		12 mA	2.11	2.43	ns		
		16 mA	2.07	2.38	ns		
	Fast	2 mA	2.50	2.88	ns		
		4 mA	1.15	1.32	ns		
		6 mA	0.96	1.10	ns		
		8 mA	0.87	1.01	ns		
		12 mA	0.79	0.91	ns		
		16 mA	0.76	0.87	ns		
		LVDCI_18			0.81	0.94	ns
		LVDCI_DV2_18			0.67	0.77	ns
LVCMOS25	Slow	2 mA	6.43	7.39	ns		
		4 mA	4.15	4.77	ns		
		6 mA	3.38	3.89	ns		
		8 mA	2.99	3.44	ns		
		12 mA	2.53	2.91	ns		
		16 mA	2.50	2.87	ns		
		24 mA	2.22	2.55	ns		
	Fast	2 mA	3.27	3.76	ns		
		4 mA	1.87	2.15	ns		
		6 mA	0.32	0.37	ns		
		8 mA	0.19	0.22	ns		
		12 mA	0	0	ns		
		16 mA	-0.02	-0.01	ns		
		24 mA	-0.04	-0.02	ns		
LVDCI_25			0.27	0.31	ns		
LVDCI_DV2_25			0.16	0.19	ns		

Table 56: Block RAM Timing

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Clock-to-Output Times						
T_{BCKO}	When reading from the Block RAM, the time from the active transition at the CLK input to data appearing at the DOUT output	–	2.09	–	2.40	ns
Setup Times						
T_{BDCK}	Time from the setup of data at the DIN inputs to the active transition at the CLK input of the Block RAM	0.43	–	0.49	–	ns
Hold Times						
T_{BCKD}	Time from the active transition at the Block RAM's CLK input to the point where data is last held at the DIN inputs	0	–	0	–	ns
Clock Timing						
T_{BPWH}	Block RAM CLK signal High pulse width	1.19	∞	1.37	∞	ns
T_{BPWL}	Block RAM CLK signal Low pulse width	1.19	∞	1.37	∞	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 32.
2. For minimums, use the values reported by the Xilinx timing analyzer.

Clock Distribution Switching Characteristics

Table 57: Clock Distribution Switching Characteristics

Description	Symbol	Maximum		Units
		Speed Grade		
		-5	-4	
Global clock buffer (BUFG, BUFGMUX, BUFGCE) I-input to O-output delay	T_{GIO}	0.36	0.41	ns
Global clock multiplexer (BUFGMUX) select S-input setup to I0- and I1-inputs. Same as BUFGCE enable CE-input	T_{GSI}	0.53	0.60	ns

Notes:

1. For minimums, use the values reported by the Xilinx timing analyzer.



Introduction

This data sheet module describes the various pins on a Spartan®-3 FPGA and how they connect to the supported component packages.

- The [Pin Types](#) section categorizes all of the FPGA pins by their function type.
- The [Pin Definitions](#) section provides a top-level description for each pin on the device.
- The [Detailed, Functional Pin Descriptions](#) section offers significantly more detail about each pin, especially for the dual- or special-function pins used during device configuration.
- Some pins have associated behavior that is controlled by settings in the configuration bitstream. These options are described in the [Bitstream Options](#) section.
- The [Package Overview](#) section describes the various packaging options available for Spartan-3 FPGAs. Detailed pin list tables and footprint diagrams are provided for each package solution.

Pin Descriptions

Pin Types

A majority of the pins on a Spartan-3 FPGA are general-purpose, user-defined I/O pins. There are, however, up to 12 different functional types of pins on Spartan-3 device packages, as outlined in [Table 69](#). In the package footprint drawings that follow, the individual pins are color-coded according to pin type as in the table.

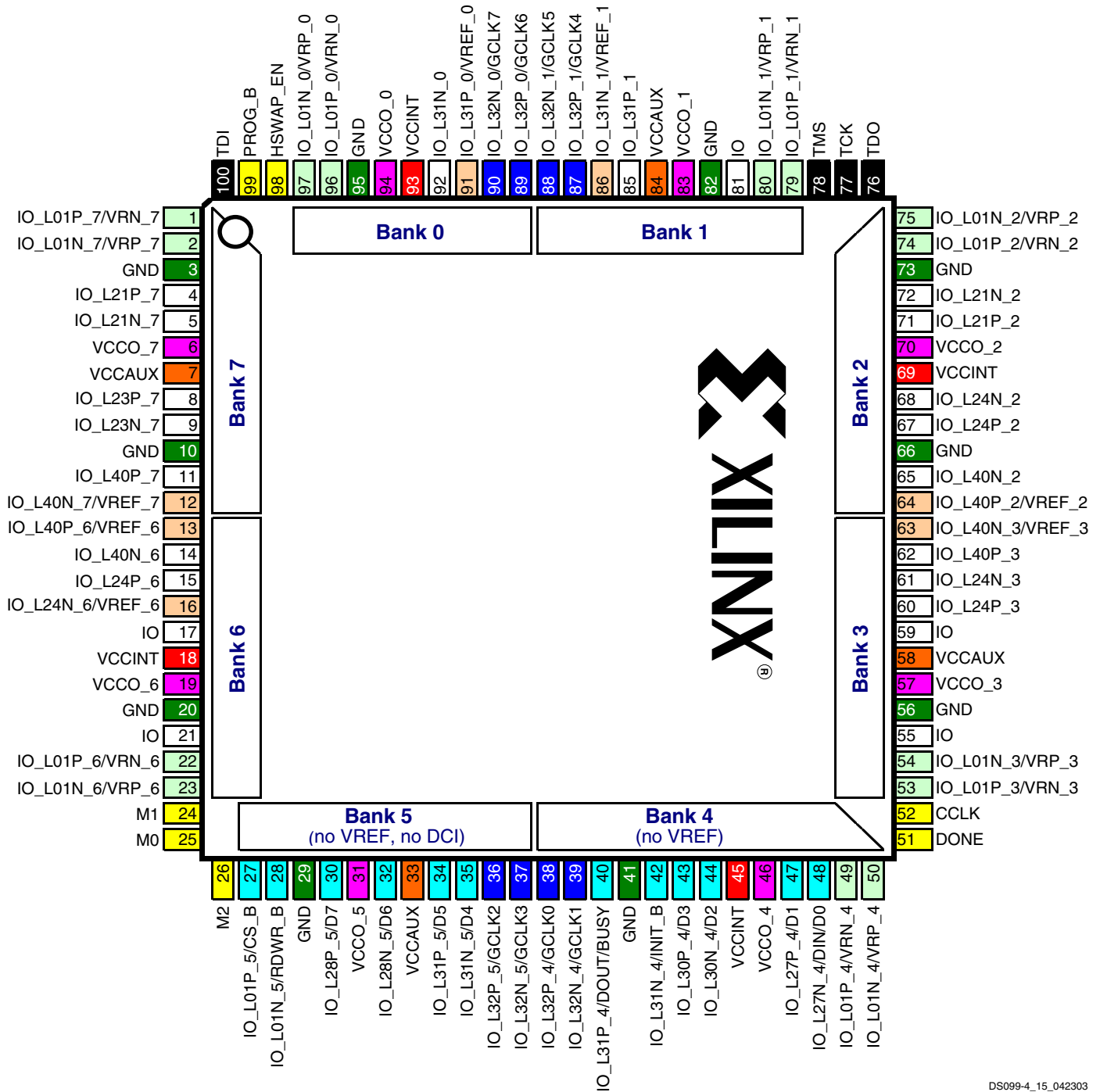
Table 69: Types of Pins on Spartan-3 FPGAs

Pin Type/ Color Code	Description	Pin Name
I/O	Unrestricted, general-purpose user-I/O pin. Most pins can be paired together to form differential I/Os.	IO, IO_Lxxy_#
DUAL	Dual-purpose pin used in some configuration modes during the configuration process and then usually available as a user I/O after configuration. If the pin is not used during configuration, this pin behaves as an I/O-type pin. There are 12 dual-purpose configuration pins on every package. The INIT_B pin has an internal pull-up resistor to VCCO_4 or VCCO_BOTTOM during configuration.	IO_Lxxy_#/DIN/D0, IO_Lxxy_#/D1, IO_Lxxy_#/D2, IO_Lxxy_#/D3, IO_Lxxy_#/D4, IO_Lxxy_#/D5, IO_Lxxy_#/D6, IO_Lxxy_#/D7, IO_Lxxy_#/CS_B, IO_Lxxy_#/RDWR_B, IO_Lxxy_#/BUSY/DOUT, IO_Lxxy_#/INIT_B
CONFIG	Dedicated configuration pin. Not available as a user-I/O pin. Every package has seven dedicated configuration pins. These pins are powered by VCCAUX and have a dedicated internal pull-up resistor to VCCAUX during configuration.	CCLK, DONE, M2, M1, M0, PROG_B, HSWAP_EN
JTAG	Dedicated JTAG pin. Not available as a user-I/O pin. Every package has four dedicated JTAG pins. These pins are powered by VCCAUX and have a dedicated internal pull-up resistor to VCCAUX during configuration.	TDI, TMS, TCK, TDO
DCI	Dual-purpose pin that is either a user-I/O pin or used to calibrate output buffer impedance for a specific bank using Digital Controlled Impedance (DCI). There are two DCI pins per I/O bank.	IO/VRN_# IO_Lxxy_#/VRN_# IO/VRP_# IO_Lxxy_#/VRP_#

Table 70: Spartan-3 FPGA Pin Definitions (Cont'd)

Pin Name	Direction	Description
GCLK: Global clock buffer inputs		
IO_Lxy_#/GCLK0, IO_Lxy_#/GCLK1, IO_Lxy_#/GCLK2, IO_Lxy_#/GCLK3, IO_Lxy_#/GCLK4, IO_Lxy_#/GCLK5, IO_Lxy_#/GCLK6, IO_Lxy_#/GCLK7	Input if connected to global clock buffers Otherwise, same as I/O	Global Buffer Input: Direct input to a low-skew global clock buffer. If not connected to a global clock buffer, this pin is a user I/O.
VREF: I/O bank input reference voltage pins		
IO_Lxy_#/VREF_# or IO/VREF_#	Voltage supply input when VREF pins are used within a bank. Otherwise, same as I/O	Input Buffer Reference Voltage for Special I/O Standards (per bank): If required to support special I/O standards, all the VREF pins within a bank connect to a input threshold voltage source. If not used as input reference voltage pins, these pins are available as individual user-I/O pins.
CONFIG: Dedicated configuration pins (pull-up resistor to VCCAUX always active during configuration, regardless of HSWAP_EN pin)		
CCLK	Input in Slave configuration modes Output in Master configuration modes	Configuration Clock: The configuration clock signal synchronizes configuration data. This pin has an internal pull-up resistor to VCCAUX during configuration.
PROG_B	Input	Program/Configure Device: Active Low asynchronous reset to configuration logic. Asserting PROG_B Low for an extended period delays the configuration process. This pin has an internal pull-up resistor to VCCAUX during configuration.
DONE	Bidirectional with open-drain or totem-pole Output	Configuration Done, Delay Start-up Sequence: A Low-to-High output transition on this bidirectional pin signals the end of the configuration process. The FPGA produces a Low-to-High transition on this pin to indicate that the configuration process is complete. The DriveDone bitstream generation option defines whether this pin functions as a totem-pole output that actively drives High or as an open-drain output. An open-drain output requires a pull-up resistor to produce a High logic level. The open-drain option permits the DONE lines of multiple FPGAs to be tied together, so that the common node transitions High only after all of the FPGAs have completed configuration. Externally holding the open-drain output Low delays the start-up sequence, which marks the transition to user mode.
M0, M1, M2	Input	Configuration Mode Selection: These inputs select the configuration mode. The logic levels applied to the mode pins are sampled on the rising edge of INIT_B. See Table 75. These pins have an internal pull-up resistor to VCCAUX during configuration, making Slave Serial the default configuration mode.
HSWAP_EN	Input	Disable Pull-up Resistors During Configuration: A Low on this pin enables pull-up resistors on all pins that are not actively involved in the configuration process. A High value disables all pull-ups, allowing the non-configuration pins to float.
JTAG: JTAG interface pins (pull-up resistor to VCCAUX always active during configuration, regardless of HSWAP_EN pin)		
TCK	Input	JTAG Test Clock: The TCK clock signal synchronizes all JTAG port operations. This pin has an internal pull-up resistor to VCCAUX during configuration.

VQ100 Footprint



DS099-4_15_042303

Figure 44: VQ100 Package Footprint (Top View). Note pin 1 indicator in top-left corner and logo orientation.

22	I/O: Unrestricted, general-purpose user I/O	12	DUAL: Configuration pin, then possible user I/O	7	VREF: User I/O or input voltage reference for bank
14	DCI: User I/O or reference resistor input for bank	8	GCLK: User I/O or global clock buffer input	8	VCCO: Output voltage supply for bank
7	CONFIG: Dedicated configuration pins	4	JTAG: Dedicated JTAG port pins	4	VCCINT: Internal core voltage supply (+1.2V)
0	N.C.: No unconnected pins in this package	10	GND: Ground	4	VCCAUX: Auxiliary voltage supply (+2.5V)

Table 89: CP132 Package Pinout (Cont'd)

Bank	XC3S50 Pin Name	CP132 Ball	Type
2	IO_L24P_2	G13	I/O
2	IO_L40N_2	G14	I/O
2	IO_L40P_2/VREF_2	H12	VREF
3	IO_L01N_3/VRP_3	N13	DCI
3	IO_L01P_3/VRN_3	N14	DCI
3	IO_L20N_3	L12	I/O
3	IO_L20P_3	M14	I/O
3	IO_L22N_3	L14	I/O
3	IO_L22P_3	L13	I/O
3	IO_L23N_3	K13	I/O
3	IO_L23P_3/VREF_3	K12	VREF
3	IO_L24N_3	J12	I/O
3	IO_L24P_3	K14	I/O
3	IO_L40N_3/VREF_3	H14	VREF
3	IO_L40P_3	J13	I/O
4	IO/VREF_4	N12	VREF
4	IO_L01N_4/VRP_4	P12	DCI
4	IO_L01P_4/VRN_4	M11	DCI
4	IO_L27N_4/DIN/D0	M10	DUAL
4	IO_L27P_4/D1	N10	DUAL
4	IO_L30N_4/D2	N9	DUAL
4	IO_L30P_4/D3	P9	DUAL
4	IO_L31N_4/INIT_B	M8	DUAL
4	IO_L31P_4/DOUT/BUSY	N8	DUAL
4	IO_L32N_4/GCLK1	P8	GCLK
4	IO_L32P_4/GCLK0	M7	GCLK
5	IO_L01N_5/RDWR_B	P2	DUAL
5	IO_L01P_5/CS_B	N2	DUAL
5	IO_L27N_5/VREF_5	M4	VREF
5	IO_L27P_5	P3	I/O
5	IO_L28N_5/D6	P4	DUAL
5	IO_L28P_5/D7	N4	DUAL
5	IO_L31N_5/D4	M6	DUAL
5	IO_L31P_5/D5	P5	DUAL
5	IO_L32N_5/GCLK3	P7	GCLK
5	IO_L32P_5/GCLK2	P6	GCLK
6	IO_L01N_6/VRP_6	L3	DCI
6	IO_L01P_6/VRN_6	M1	DCI
6	IO_L20N_6	K3	I/O
6	IO_L20P_6	K2	I/O

Table 93: PQ208 Package Pinout (Cont'd)

Bank	XC3S50 Pin Name	XC3S200, XC3S400 Pin Names	PQ208 Pin Number	Type
1	IO_L10N_1/VREF_1	IO_L10N_1/VREF_1	P166	VREF
1	IO_L10P_1	IO_L10P_1	P165	I/O
1	IO_L27N_1	IO_L27N_1	P169	I/O
1	IO_L27P_1	IO_L27P_1	P168	I/O
1	IO_L28N_1	IO_L28N_1	P172	I/O
1	IO_L28P_1	IO_L28P_1	P171	I/O
1	IO_L31N_1/VREF_1	IO_L31N_1/VREF_1	P178	VREF
1	IO_L31P_1	IO_L31P_1	P176	I/O
1	IO_L32N_1/GCLK5	IO_L32N_1/GCLK5	P181	GCLK
1	IO_L32P_1/GCLK4	IO_L32P_1/GCLK4	P180	GCLK
1	VCCO_1	VCCO_1	P164	VCCO
1	VCCO_1	VCCO_1	P177	VCCO
2	N.C. (◆)	IO/VREF_2	P154	VREF
2	IO_L01N_2/VRP_2	IO_L01N_2/VRP_2	P156	DCI
2	IO_L01P_2/VRN_2	IO_L01P_2/VRN_2	P155	DCI
2	IO_L19N_2	IO_L19N_2	P152	I/O
2	IO_L19P_2	IO_L19P_2	P150	I/O
2	IO_L20N_2	IO_L20N_2	P149	I/O
2	IO_L20P_2	IO_L20P_2	P148	I/O
2	IO_L21N_2	IO_L21N_2	P147	I/O
2	IO_L21P_2	IO_L21P_2	P146	I/O
2	IO_L22N_2	IO_L22N_2	P144	I/O
2	IO_L22P_2	IO_L22P_2	P143	I/O
2	IO_L23N_2/VREF_2	IO_L23N_2/VREF_2	P141	VREF
2	IO_L23P_2	IO_L23P_2	P140	I/O
2	IO_L24N_2	IO_L24N_2	P139	I/O
2	IO_L24P_2	IO_L24P_2	P138	I/O
2	N.C. (◆)	IO_L39N_2	P137	I/O
2	N.C. (◆)	IO_L39P_2	P135	I/O
2	IO_L40N_2	IO_L40N_2	P133	I/O
2	IO_L40P_2/VREF_2	IO_L40P_2/VREF_2	P132	VREF
2	VCCO_2	VCCO_2	P136	VCCO
2	VCCO_2	VCCO_2	P153	VCCO
3	IO_L01N_3/VRP_3	IO_L01N_3/VRP_3	P107	DCI
3	IO_L01P_3/VRN_3	IO_L01P_3/VRN_3	P106	DCI
3	N.C. (◆)	IO_L17N_3	P109	I/O
3	N.C. (◆)	IO_L17P_3/VREF_3	P108	VREF
3	IO_L19N_3	IO_L19N_3	P113	I/O
3	IO_L19P_3	IO_L19P_3	P111	I/O
3	IO_L20N_3	IO_L20N_3	P115	I/O

Table 96: FT256 Package Pinout (Cont'd)

Bank	XC3S200, XC3S400, XC3S1000 Pin Name	FT256 Pin Number	Type
2	VCCO_2	G11	VCCO
2	VCCO_2	H11	VCCO
2	VCCO_2	H12	VCCO
3	IO	K15	I/O
3	IO_L01N_3/VRP_3	P16	DCI
3	IO_L01P_3/VRN_3	R16	DCI
3	IO_L16N_3	P15	I/O
3	IO_L16P_3	P14	I/O
3	IO_L17N_3	N16	I/O
3	IO_L17P_3/VREF_3	N15	VREF
3	IO_L19N_3	M14	I/O
3	IO_L19P_3	N14	I/O
3	IO_L20N_3	M16	I/O
3	IO_L20P_3	M15	I/O
3	IO_L21N_3	L13	I/O
3	IO_L21P_3	M13	I/O
3	IO_L22N_3	L15	I/O
3	IO_L22P_3	L14	I/O
3	IO_L23N_3	K12	I/O
3	IO_L23P_3/VREF_3	L12	VREF
3	IO_L24N_3	K14	I/O
3	IO_L24P_3	K13	I/O
3	IO_L39N_3	J14	I/O
3	IO_L39P_3	J13	I/O
3	IO_L40N_3/VREF_3	J16	VREF
3	IO_L40P_3	K16	I/O
3	VCCO_3	J11	VCCO
3	VCCO_3	J12	VCCO
3	VCCO_3	K11	VCCO
4	IO	T12	I/O
4	IO	T14	I/O
4	IO/VREF_4	N12	VREF
4	IO/VREF_4	P13	VREF
4	IO/VREF_4	T10	VREF
4	IO_L01N_4/VRP_4	R13	DCI
4	IO_L01P_4/VRN_4	T13	DCI
4	IO_L25N_4	P12	I/O
4	IO_L25P_4	R12	I/O
4	IO_L27N_4/DIN/D0	M11	DUAL
4	IO_L27P_4/D1	N11	DUAL

Table 100: FG456 Package Pinout (Cont'd)

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
7	IO_L23N_7	IO_L23N_7	F2	I/O
7	IO_L23P_7	IO_L23P_7	F3	I/O
7	IO_L24N_7	IO_L24N_7	H5	I/O
7	IO_L24P_7	IO_L24P_7	G5	I/O
7	N.C. (◆)	IO_L26N_7	G3	I/O
7	N.C. (◆)	IO_L26P_7	G4	I/O
7	IO_L27N_7	IO_L27N_7	G1	I/O
7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	G2	VREF
7	N.C. (◆)	IO_L28N_7	H1	I/O
7	N.C. (◆)	IO_L28P_7	H2	I/O
7	N.C. (◆)	IO_L29N_7	J4	I/O
7	N.C. (◆)	IO_L29P_7	H4	I/O
7	N.C. (◆)	IO_L31N_7	J5	I/O
7	N.C. (◆)	IO_L31P_7	J6	I/O
7	N.C. (◆)	IO_L32N_7	J1	I/O
7	N.C. (◆)	IO_L32P_7	J2	I/O
7	N.C. (◆)	IO_L33N_7	K5	I/O
7	N.C. (◆)	IO_L33P_7	K6	I/O
7	IO_L34N_7	IO_L34N_7	K3	I/O
7	IO_L34P_7	IO_L34P_7	K4	I/O
7	IO_L35N_7	IO_L35N_7	K1	I/O
7	IO_L35P_7	IO_L35P_7	K2	I/O
7	IO_L38N_7	IO_L38N_7	L5	I/O
7	IO_L38P_7	IO_L38P_7	L6	I/O
7	IO_L39N_7	IO_L39N_7	L3	I/O
7	IO_L39P_7	IO_L39P_7	L4	I/O
7	IO_L40N_7/VREF_7	IO_L40N_7/VREF_7	L1	VREF
7	IO_L40P_7	IO_L40P_7	L2	I/O
7	VCCO_7	VCCO_7	H3	VCCO
7	VCCO_7	VCCO_7	H6	VCCO
7	VCCO_7	VCCO_7	J7	VCCO
7	VCCO_7	VCCO_7	K7	VCCO
7	VCCO_7	VCCO_7	L7	VCCO
N/A	GND	GND	A1	GND
N/A	GND	GND	A22	GND
N/A	GND	GND	AA2	GND
N/A	GND	GND	AA21	GND
N/A	GND	GND	AB1	GND
N/A	GND	GND	AB22	GND
N/A	GND	GND	B2	GND

Table 100: FG456 Package Pinout (Cont'd)

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
N/A	GND	GND	B21	GND
N/A	GND	GND	C9	GND
N/A	GND	GND	C14	GND
N/A	GND	GND	J3	GND
N/A	GND	GND	J9	GND
N/A	GND	GND	J10	GND
N/A	GND	GND	J11	GND
N/A	GND	GND	J12	GND
N/A	GND	GND	J13	GND
N/A	GND	GND	J14	GND
N/A	GND	GND	J20	GND
N/A	GND	GND	K9	GND
N/A	GND	GND	K10	GND
N/A	GND	GND	K11	GND
N/A	GND	GND	K12	GND
N/A	GND	GND	K13	GND
N/A	GND	GND	K14	GND
N/A	GND	GND	L9	GND
N/A	GND	GND	L10	GND
N/A	GND	GND	L11	GND
N/A	GND	GND	L12	GND
N/A	GND	GND	L13	GND
N/A	GND	GND	L14	GND
N/A	GND	GND	M9	GND
N/A	GND	GND	M10	GND
N/A	GND	GND	M11	GND
N/A	GND	GND	M12	GND
N/A	GND	GND	M13	GND
N/A	GND	GND	M14	GND
N/A	GND	GND	N9	GND
N/A	GND	GND	N10	GND
N/A	GND	GND	N11	GND
N/A	GND	GND	N12	GND
N/A	GND	GND	N13	GND
N/A	GND	GND	N14	GND
N/A	GND	GND	P3	GND
N/A	GND	GND	P9	GND
N/A	GND	GND	P10	GND
N/A	GND	GND	P11	GND
N/A	GND	GND	P12	GND

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
6	IO_L20N_6	IO_L20N_6	IO_L20N_6	IO_L20N_6	IO_L20N_6	V7	I/O
6	IO_L20P_6	IO_L20P_6	IO_L20P_6	IO_L20P_6	IO_L20P_6	U7	I/O
6	IO_L21N_6	IO_L21N_6	IO_L21N_6	IO_L21N_6	IO_L21N_6	V5	I/O
6	IO_L21P_6	IO_L21P_6	IO_L21P_6	IO_L21P_6	IO_L21P_6	V4	I/O
6	IO_L22N_6	IO_L22N_6	IO_L22N_6	IO_L22N_6	IO_L22N_6	V3	I/O
6	IO_L22P_6	IO_L22P_6	IO_L22P_6	IO_L22P_6	IO_L22P_6	V2	I/O
6	IO_L23N_6	IO_L23N_6	IO_L23N_6	IO_L23N_6	IO_L23N_6	U6	I/O
6	IO_L23P_6	IO_L23P_6	IO_L23P_6	IO_L23P_6	IO_L23P_6	U5	I/O
6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	IO_L24N_6/VREF_6	U4	VREF
6	IO_L24P_6	IO_L24P_6	IO_L24P_6	IO_L24P_6	IO_L24P_6	U3	I/O
6	IO_L26N_6	IO_L26N_6	IO_L26N_6	IO_L26N_6	IO_L26N_6	U2	I/O
6	IO_L26P_6	IO_L26P_6	IO_L26P_6	IO_L26P_6	IO_L26P_6	U1	I/O
6	IO_L27N_6	IO_L27N_6	IO_L27N_6	IO_L27N_6	IO_L27N_6	T8	I/O
6	IO_L27P_6	IO_L27P_6	IO_L27P_6	IO_L27P_6	IO_L27P_6	T7	I/O
6	IO_L28N_6	IO_L28N_6	IO_L28N_6	IO_L28N_6	IO_L28N_6	T6	I/O
6	IO_L28P_6	IO_L28P_6	IO_L28P_6	IO_L28P_6	IO_L28P_6	T5	I/O
6	IO_L29N_6	IO_L29N_6	IO_L29N_6	IO_L29N_6	IO_L29N_6	T2	I/O
6	IO_L29P_6	IO_L29P_6	IO_L29P_6	IO_L29P_6	IO_L29P_6	T1	I/O
6	IO_L31N_6	IO_L31N_6	IO_L31N_6	IO_L31N_6	IO_L31N_6	R8	I/O
6	IO_L31P_6	IO_L31P_6	IO_L31P_6	IO_L31P_6	IO_L31P_6	R7	I/O
6	IO_L32N_6	IO_L32N_6	IO_L32N_6	IO_L32N_6	IO_L32N_6	R6	I/O
6	IO_L32P_6	IO_L32P_6	IO_L32P_6	IO_L32P_6	IO_L32P_6	R5	I/O
6	IO_L33N_6	IO_L33N_6	IO_L33N_6	IO_L33N_6	IO_L33N_6	T4	I/O
6	IO_L33P_6	IO_L33P_6	IO_L33P_6	IO_L33P_6	IO_L33P_6	R3	I/O
6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	IO_L34N_6/VREF_6	R2	VREF
6	IO_L34P_6	IO_L34P_6	IO_L34P_6	IO_L34P_6	IO_L34P_6	R1	I/O
6	IO_L35N_6	IO_L35N_6	IO_L35N_6	IO_L35N_6	IO_L35N_6	P8	I/O
6	IO_L35P_6	IO_L35P_6	IO_L35P_6	IO_L35P_6	IO_L35P_6	P7	I/O
6	IO_L38N_6	IO_L38N_6	IO_L38N_6	IO_L38N_6	IO_L38N_6	P6	I/O
6	IO_L38P_6	IO_L38P_6	IO_L38P_6	IO_L38P_6	IO_L38P_6	P5	I/O
6	IO_L39N_6	IO_L39N_6	IO_L39N_6	IO_L39N_6	IO_L39N_6	P4	I/O
6	IO_L39P_6	IO_L39P_6	IO_L39P_6	IO_L39P_6	IO_L39P_6	P3	I/O
6	IO_L40N_6	IO_L40N_6	IO_L40N_6	IO_L40N_6	IO_L40N_6	P2	I/O
6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	IO_L40P_6/VREF_6	P1	VREF
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	P9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	P10	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	R9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	T3	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	T9	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	U8	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	V8	VCCO
6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	VCCO_6	Y3	VCCO
7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	IO_L01N_7/VRP_7	F5	DCI

Table 103: FG676 Package Pinout (Cont'd)

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	F6	DCI
7	IO_L02N_7	IO_L02N_7	IO_L02N_7	IO_L02N_7	IO_L02N_7	E3	I/O
7	IO_L02P_7	IO_L02P_7	IO_L02P_7	IO_L02P_7	IO_L02P_7	E4	I/O
7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	D1	VREF
7	IO_L03P_7	IO_L03P_7	IO_L03P_7	IO_L03P_7	IO_L03P_7	D2	I/O
7	N.C. (◆)	IO_L05N_7	IO_L05N_7	IO_L05N_7	IO_L05N_7	G6	I/O
7	N.C. (◆)	IO_L05P_7	IO_L05P_7	IO_L05P_7	IO_L05P_7	G7	I/O
7	N.C. (◆)	IO_L06N_7	IO_L06N_7	IO_L06N_7	IO_L06N_7	E1	I/O
7	N.C. (◆)	IO_L06P_7	IO_L06P_7	IO_L06P_7	IO_L06P_7	E2	I/O
7	N.C. (◆)	IO_L07N_7	IO_L07N_7	IO_L07N_7	IO_L07N_7	F3	I/O
7	N.C. (◆)	IO_L07P_7	IO_L07P_7	IO_L07P_7	IO_L07P_7	F4	I/O
7	N.C. (◆)	IO_L08N_7	IO_L08N_7	IO_L08N_7	IO_L08N_7	G4	I/O
7	N.C. (◆)	IO_L08P_7	IO_L08P_7	IO_L08P_7	IO_L08P_7	G5	I/O
7	N.C. (◆)	IO_L09N_7	IO_L09N_7	IO_L09N_7	IO_L09N_7	F1	I/O
7	N.C. (◆)	IO_L09P_7	IO_L09P_7	IO_L09P_7	IO_L09P_7	F2	I/O
7	N.C. (◆)	IO_L10N_7	IO_L10N_7	IO_L10N_7	IO_L10N_7	H6	I/O
7	N.C. (◆)	IO_L10P_7/VREF_7	IO_L10P_7/VREF_7	IO_L10P_7/VREF_7	IO_L10P_7/VREF_7	H7	VREF
7	IO_L14N_7	IO_L14N_7	IO_L14N_7	IO_L14N_7	IO_L14N_7	G1	I/O
7	IO_L14P_7	IO_L14P_7	IO_L14P_7	IO_L14P_7	IO_L14P_7	G2	I/O
7	IO_L16N_7	IO_L16N_7	IO_L16N_7	IO_L16N_7	IO_L16N_7	J6	I/O
7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	H5	VREF
7	IO_L17N_7	IO_L17N_7	IO_L17N_7	IO_L17N_7	IO_L17N_7	H3	I/O
7	IO_L17P_7	IO_L17P_7	IO_L17P_7	IO_L17P_7	IO_L17P_7	H4	I/O
7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	H1	VREF
7	IO_L19P_7	IO_L19P_7	IO_L19P_7	IO_L19P_7	IO_L19P_7	H2	I/O
7	IO_L20N_7	IO_L20N_7	IO_L20N_7	IO_L20N_7	IO_L20N_7	K7	I/O
7	IO_L20P_7	IO_L20P_7	IO_L20P_7	IO_L20P_7	IO_L20P_7	J7	I/O
7	IO_L21N_7	IO_L21N_7	IO_L21N_7	IO_L21N_7	IO_L21N_7	J4	I/O
7	IO_L21P_7	IO_L21P_7	IO_L21P_7	IO_L21P_7	IO_L21P_7	J5	I/O
7	IO_L22N_7	IO_L22N_7	IO_L22N_7	IO_L22N_7	IO_L22N_7	J2	I/O
7	IO_L22P_7	IO_L22P_7	IO_L22P_7	IO_L22P_7	IO_L22P_7	J3	I/O
7	IO_L23N_7	IO_L23N_7	IO_L23N_7	IO_L23N_7	IO_L23N_7	K5	I/O
7	IO_L23P_7	IO_L23P_7	IO_L23P_7	IO_L23P_7	IO_L23P_7	K6	I/O
7	IO_L24N_7	IO_L24N_7	IO_L24N_7	IO_L24N_7	IO_L24N_7	K3	I/O
7	IO_L24P_7	IO_L24P_7	IO_L24P_7	IO_L24P_7	IO_L24P_7	K4	I/O
7	IO_L26N_7	IO_L26N_7	IO_L26N_7	IO_L26N_7	IO_L26N_7	K1	I/O
7	IO_L26P_7	IO_L26P_7	IO_L26P_7	IO_L26P_7	IO_L26P_7	K2	I/O
7	IO_L27N_7	IO_L27N_7	IO_L27N_7	IO_L27N_7	IO_L27N_7	L7	I/O
7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	IO_L27P_7/VREF_7	L8	VREF
7	IO_L28N_7	IO_L28N_7	IO_L28N_7	IO_L28N_7	IO_L28N_7	L5	I/O
7	IO_L28P_7	IO_L28P_7	IO_L28P_7	IO_L28P_7	IO_L28P_7	L6	I/O
7	IO_L29N_7	IO_L29N_7	IO_L29N_7	IO_L29N_7	IO_L29N_7	L1	I/O

User I/Os by Bank

Table 108 indicates how the available user-I/O pins are distributed between the eight I/O banks for the XC3S2000 in the FG900 package. Similarly, Table 109 shows how the available user-I/O pins are distributed between the eight I/O banks for the XC3S4000 and XC3S5000 in the FG900 package.

Table 108: User I/Os Per Bank for XC3S2000 in FG900 Package

Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	DUAL	DCI	VREF	GCLK
Top	0	71	62	0	2	5	2
	1	71	62	0	2	5	2
Right	2	69	61	0	2	6	0
	3	71	62	0	2	7	0
Bottom	4	72	57	6	2	5	2
	5	71	55	6	2	6	2
Left	6	69	60	0	2	7	0
	7	71	62	0	2	7	0

Table 109: User I/Os Per Bank for XC3S4000 and XC3S5000 in FG900 Package

Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	DUAL	DCI	VREF	GCLK
Top	0	79	70	0	2	5	2
	1	79	70	0	2	5	2
Right	2	79	71	0	2	6	0
	3	79	70	0	2	7	0
Bottom	4	80	65	6	2	5	2
	5	79	63	6	2	6	2
Left	6	79	70	0	2	7	0
	7	79	70	0	2	7	0

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
0	IO_L03P_0	IO_L03P_0	B5	I/O
0	IO_L04N_0	IO_L04N_0	D6	I/O
0	IO_L04P_0	IO_L04P_0	C6	I/O
0	IO_L05N_0	IO_L05N_0	B6	I/O
0	IO_L05P_0/VREF_0	IO_L05P_0/VREF_0	A6	VREF
0	IO_L06N_0	IO_L06N_0	F7	I/O
0	IO_L06P_0	IO_L06P_0	E7	I/O
0	IO_L07N_0	IO_L07N_0	G9	I/O
0	IO_L07P_0	IO_L07P_0	F9	I/O
0	IO_L08N_0	IO_L08N_0	D9	I/O
0	IO_L08P_0	IO_L08P_0	C9	I/O
0	IO_L09N_0	IO_L09N_0	J10	I/O
0	IO_L09P_0	IO_L09P_0	H10	I/O
0	IO_L10N_0	IO_L10N_0	G10	I/O
0	IO_L10P_0	IO_L10P_0	F10	I/O
0	IO_L11N_0	IO_L11N_0	L12	I/O
0	IO_L11P_0	IO_L11P_0	K12	I/O
0	IO_L12N_0	IO_L12N_0	J12	I/O
0	IO_L12P_0	IO_L12P_0	H12	I/O
0	IO_L13N_0	IO_L13N_0	F12	I/O
0	IO_L13P_0	IO_L13P_0	E12	I/O
0	IO_L14N_0	IO_L14N_0	D12	I/O
0	IO_L14P_0	IO_L14P_0	C12	I/O
0	IO_L15N_0	IO_L15N_0	B12	I/O
0	IO_L15P_0	IO_L15P_0	A12	I/O
0	IO_L16N_0	IO_L16N_0	H13	I/O
0	IO_L16P_0	IO_L16P_0	G13	I/O
0	IO_L17N_0	IO_L17N_0	D13	I/O
0	IO_L17P_0	IO_L17P_0	C13	I/O
0	IO_L18N_0	IO_L18N_0	L14	I/O
0	IO_L18P_0	IO_L18P_0	K14	I/O
0	IO_L19N_0	IO_L19N_0	H14	I/O
0	IO_L19P_0	IO_L19P_0	G14	I/O
0	IO_L20N_0	IO_L20N_0	F14	I/O
0	IO_L20P_0	IO_L20P_0	E14	I/O
0	IO_L21N_0	IO_L21N_0	D14	I/O
0	IO_L21P_0	IO_L21P_0	C14	I/O
0	IO_L22N_0	IO_L22N_0	B14	I/O
0	IO_L22P_0	IO_L22P_0	A14	I/O
0	IO_L23N_0	IO_L23N_0	K15	I/O

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
5	IO_L24P_5	IO_L24P_5	AH15	I/O
5	IO_L25N_5	IO_L25N_5	AM15	I/O
5	IO_L25P_5	IO_L25P_5	AL15	I/O
5	IO_L26N_5	IO_L26N_5	AP15	I/O
5	IO_L26P_5	IO_L26P_5	AN15	I/O
5	IO_L27N_5/VREF_5	IO_L27N_5/VREF_5	AJ16	VREF
5	IO_L27P_5	IO_L27P_5	AH16	I/O
5	IO_L28N_5/D6	IO_L28N_5/D6	AN16	DUAL
5	IO_L28P_5/D7	IO_L28P_5/D7	AM16	DUAL
5	IO_L29N_5	IO_L29N_5	AF17	I/O
5	IO_L29P_5/VREF_5	IO_L29P_5/VREF_5	AE17	VREF
5	IO_L30N_5	IO_L30N_5	AH17	I/O
5	IO_L30P_5	IO_L30P_5	AG17	I/O
5	IO_L31N_5/D4	IO_L31N_5/D4	AL17	DUAL
5	IO_L31P_5/D5	IO_L31P_5/D5	AK17	DUAL
5	IO_L32N_5/GCLK3	IO_L32N_5/GCLK3	AN17	GCLK
5	IO_L32P_5/GCLK2	IO_L32P_5/GCLK2	AM17	GCLK
5	N.C. (◆)	IO_L33N_5	AM7	I/O
5	N.C. (◆)	IO_L33P_5	AL7	I/O
5	N.C. (◆)	IO_L34N_5	AP7	I/O
5	N.C. (◆)	IO_L34P_5	AN7	I/O
5	IO_L35N_5	IO_L35N_5	AL8	I/O
5	IO_L35P_5	IO_L35P_5	AK8	I/O
5	IO_L36N_5	IO_L36N_5	AP8	I/O
5	IO_L36P_5	IO_L36P_5	AN8	I/O
5	IO_L37N_5	IO_L37N_5	AJ9	I/O
5	IO_L37P_5	IO_L37P_5	AH9	I/O
5	IO_L38N_5	IO_L38N_5	AM9	I/O
5	IO_L38P_5	IO_L38P_5	AL9	I/O
5	N.C. (◆)	IO_L39N_5	AF11	I/O
5	N.C. (◆)	IO_L39P_5	AE11	I/O
5	N.C. (◆)	IO_L40N_5	AJ11	I/O
5	N.C. (◆)	IO_L40P_5	AH11	I/O
5	VCCO_5	VCCO_5	AC13	VCCO
5	VCCO_5	VCCO_5	AC14	VCCO
5	VCCO_5	VCCO_5	AC15	VCCO
5	VCCO_5	VCCO_5	AC16	VCCO
5	VCCO_5	VCCO_5	AG11	VCCO
5	VCCO_5	VCCO_5	AG15	VCCO
5	VCCO_5	VCCO_5	AH8	VCCO

Table 110: FG1156 Package Pinout (Cont'd)

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
N/A	GND	GND	Y14	GND
N/A	GND	GND	Y15	GND
N/A	GND	GND	Y16	GND
N/A	GND	GND	Y17	GND
N/A	GND	GND	Y18	GND
N/A	GND	GND	Y19	GND
N/A	GND	GND	Y20	GND
N/A	GND	GND	Y21	GND
N/A	N.C. (◆)	N.C. (■)	AK31	N.C.
N/A	VCCAUX	VCCAUX	AD30	VCCAUX
N/A	VCCAUX	VCCAUX	AD5	VCCAUX
N/A	VCCAUX	VCCAUX	AG16	VCCAUX
N/A	VCCAUX	VCCAUX	AG19	VCCAUX
N/A	VCCAUX	VCCAUX	AJ30	VCCAUX
N/A	VCCAUX	VCCAUX	AJ5	VCCAUX
N/A	VCCAUX	VCCAUX	AK11	VCCAUX
N/A	VCCAUX	VCCAUX	AK15	VCCAUX
N/A	VCCAUX	VCCAUX	AK20	VCCAUX
N/A	VCCAUX	VCCAUX	AK24	VCCAUX
N/A	VCCAUX	VCCAUX	AK29	VCCAUX
N/A	VCCAUX	VCCAUX	AK6	VCCAUX
N/A	VCCAUX	VCCAUX	E11	VCCAUX
N/A	VCCAUX	VCCAUX	E15	VCCAUX
N/A	VCCAUX	VCCAUX	E20	VCCAUX
N/A	VCCAUX	VCCAUX	E24	VCCAUX
N/A	VCCAUX	VCCAUX	E29	VCCAUX
N/A	VCCAUX	VCCAUX	E6	VCCAUX
N/A	VCCAUX	VCCAUX	F30	VCCAUX
N/A	VCCAUX	VCCAUX	F5	VCCAUX
N/A	VCCAUX	VCCAUX	H16	VCCAUX
N/A	VCCAUX	VCCAUX	H19	VCCAUX
N/A	VCCAUX	VCCAUX	L30	VCCAUX
N/A	VCCAUX	VCCAUX	L5	VCCAUX
N/A	VCCAUX	VCCAUX	R30	VCCAUX
N/A	VCCAUX	VCCAUX	R5	VCCAUX
N/A	VCCAUX	VCCAUX	T27	VCCAUX
N/A	VCCAUX	VCCAUX	T8	VCCAUX
N/A	VCCAUX	VCCAUX	W27	VCCAUX
N/A	VCCAUX	VCCAUX	W8	VCCAUX
N/A	VCCAUX	VCCAUX	Y30	VCCAUX

18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	33	34	
GND	GND	GND	GND	GND	VCCINT	I/O L51N_3 ◆	I/O	I/O	I/O L37P_3	I/O L37N_3	I/O L38P_3	I/O L38N_3	I/O L39P_3	I/O L39N_3	I/O L40P_3	I/O L40N_3 VREF_3	V
GND	GND	GND	GND	VCCINT	VCCO_3	I/O L51P_3 ◆	I/O L33N_3	GND	VCCAUX	I/O L34P_3 VREF_3	I/O L34N_3	GND	VCCO_3	I/O L35P_3	I/O L35N_3	GND	W
GND	GND	GND	GND	VCCINT	VCCO_3	I/O L50P_3	I/O L50N_3	I/O L33P_3	VCCO_3	I/O L30P_3	I/O L30N_3	VCCAUX	I/O L31P_3	I/O L31N_3	I/O L32P_3	I/O L32N_3	Y
GND	GND	GND	GND	VCCINT	VCCO_3	I/O L48N_3 ◆	I/O L49P_3 ◆	I/O L49N_3 ◆	I/O L26P_3	I/O L26N_3	I/O L27P_3	I/O L27N_3	I/O L28P_3	I/O L28N_3	I/O L29P_3	I/O L29N_3	AA
GND	VCCINT	VCCINT	VCCINT	VCCINT	VCCO_3	I/O L48P_3	I/O L24N_3	GND	I/O L46P_3	I/O L46N_3	VCCO_3	GND	I/O L47P_3	I/O L47N_3	VCCO_3	GND	AB
VCCINT	VCCO_4	VCCO_4	VCCO_4	VCCO_4	VCCINT	I/O L20P_3	I/O L20N_3	I/O L24P_3	I/O L21P_3	I/O L21N_3	I/O L22P_3	I/O L22N_3	I/O L23P_3 VREF_3	I/O L23N_3	I/O L45P_3	I/O L45N_3	AC
I/O	I/O	I/O	I/O L18N_4	I/O	I/O L11N_4	DONE	I/O L17P_3 VREF_3	I/O L17N_3	VCCO_3	I/O L44P_3 ◆	I/O L44N_3 ◆	VCCAUX	VCCO_3	GND	I/O L19P_3	I/O L19N_3	AD
I/O	I/O	I/O L23N_4	I/O L18P_4	I/O	I/O L11P_4	I/O ◆	GND	I/O L12N_3	I/O L13P_3	I/O L13N_3 VREF_3	I/O L14P_3	I/O L14N_3	I/O L15P_3	I/O L15N_3	I/O L16P_3	I/O L16N_3	AE Bank 3
I/O L29N_4	GND	I/O L23P_4	I/O VREF_4	GND	I/O L12N_4	I/O	I/O L07N_4 ◆	I/O	I/O L12P_3	I/O L09P_3 VREF_3	I/O L09N_3	GND	I/O L10N_3	I/O L11P_3	I/O L11N_3	GND	AF
I/O L29P_4	VCCAUX	VCCO_4	I/O L19N_4	I/O L16N_4	I/O L12P_4	VCCO_4	I/O L07P_4	I/O	I/O	VCCO_3	I/O L07P_3	I/O L07N_3	I/O L10P_3	VCCO_3	I/O L08P_3	I/O L08N_3	AG
I/O L30N_4 D2	I/O L27N_4 DIN D0	I/O L24N_4	I/O L19P_4	I/O L16P_4	I/O VREF_4	I/O L39N_4 ◆	I/O L08N_4	I/O L05N_4	VCCO_4	GND	I/O L06P_3	I/O L06N_3	I/O L41P_3 ◆	I/O L41N_3 ◆	I/O	I/O	AH
I/O L30P_4 D3	I/O L27P_4 D1	I/O L24P_4	I/O L20N_4	VCCO_4	I/O L13N_4	I/O L39P_4 ◆	I/O L08P_4	I/O L05P_4	I/O	I/O L35N_4	I/O	VCCAUX	I/O L04P_3	I/O L04N_3	I/O L05P_3	I/O L05N_3	AJ
I/O VREF_4	GND	VCCAUX	I/O L20P_4	GND	I/O L13P_4	VCCAUX	I/O	GND	I/O L38N_4	I/O L35P_4	VCCAUX	GND	N.C. ◆ ■	I/O L03P_3	I/O L03N_3	GND	AK
I/O L31N_4 INIT_B	VCCO_4	I/O L25N_4	I/O L21N_4	I/O L17N_4	I/O L14N_4	VCCO_4	I/O L09N_4	I/O L06N_4 VREF_4	I/O L38P_4	I/O L36N_4 ◆	I/O L33N_4	I/O VREF_4	CCLK	VCCO_3	I/O L02P_3	I/O L02N_3 VREF_3	AL
I/O L31P_4 DOUT BUSY	I/O L28N_4	I/O L25P_4	I/O L21P_4	I/O L17P_4	I/O L14P_4	GND	I/O L09P_4	I/O L06P_4	VCCO_4	I/O L36P_4 ◆	I/O L33P_4	I/O L03N_4	VCCO_4	GND	I/O L01P_3 VRN_3	I/O L01N_3 VRP_3	AM
I/O L32N_4 GCLK1	I/O L28P_4	I/O L26N_4	I/O L22N_4 VREF_4	VCCO_4	I/O L15N_4	I/O L40N_4 ◆	I/O L10N_4	I/O	I/O L04N_4	I/O L37N_4 ◆	I/O L34N_4	I/O L03P_4	I/O L02N_4	I/O L01N_4 VRP_4	GND	GND	AN
I/O L32P_4 GCLK0	GND	I/O L26P_4 VREF_4	I/O L22P_4	GND	I/O L15P_4	I/O L40P_4 ◆	I/O L10P_4	GND	I/O L04P_4	I/O L37P_4 ◆	I/O L34P_4	GND	I/O L02P_4	I/O L01P_4 VRN_4	GND	GND	AP

Bank 4

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Bottom Right Corner of FG1156 Package (Top View)

Figure 60: FG1156 Package Footprint (Top View) Continued